

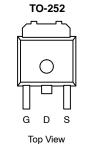
# N-Channel 60-V (D-S), 175°C MOSFET, Logic Level

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	
60	0.022 @ V <sub>GS</sub> = 10 V	30	
	0.025 @ V <sub>GS</sub> = 4.5 V	30	

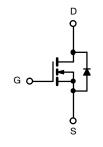
### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 175°C Maximum Junction
- Temperature
  100% R<sub>q</sub> Tested





Drain Connected to Tab



N-Channel MOSFET

Ordering Information:

n: SUD40N06-25L SUD40N06-25L—E3 (Lead (Pb)-Free)

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = $25^{\circ}$ C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V <sub>GS</sub>	±20	V	
	$T_{C} = 25^{\circ}C$		30		
Continuous Drain Current (T <sub>J</sub> = 175°C) <sup>b</sup>	$T_{C} = 100^{\circ}C$	ID ID	30		
Pulsed Drain Current		I <sub>DM</sub>	100	А	
Continuous Source Current (Diode Conduction)		I <sub>S</sub>	34		
Avalanche Current		I <sub>AR</sub>	34		
Repetitive Avalanche Energy (Duty Cycle $\leq$ 1%)	L = 0.1 mH	E <sub>AR</sub>	58	mJ	
Maximum Power Dissipation	$T_{C} = 25^{\circ}C$		75		
	$T_A = 25^{\circ}C$	P <sub>D</sub>	1.4 <sup>b</sup> , 2.5 <sup>c</sup>	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Maximum Junction-to-Ambient	Free Air, FR4 Board Mount		60		
	Free Air, Vertical Mount	R <sub>thJA</sub>	110	°C/W	
Maximum Junction-to-Case		R <sub>thJC</sub>	2.0		

Notes:

a. Package limited.

b. Free air, vertical mount.

c. Surface mounted on 1" x 1" FR4 Board, t  $\leq$  10 sec.

For SPICE model information via the Worldwide Web: http://www.vishay.com/www/product/spice.htm

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SPECIFICATIONS (T <sub>J</sub> = $25^{\circ}$ C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тура	Max	Unit		
Static								
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_D = 250 \ \mu\text{A}$	60			v		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0	2.0	3.0	v		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm20$ V			±100	nA		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V 1					
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 $^{\circ}C$			50	μA		
		$V_{DS}$ = 60 V, $V_{GS}$ = 0 V, $T_J$ = 175 $^\circ C$			150	-1		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α		
		$V_{GS}$ = 10 V, $I_D$ = 20 A			0.022			
		$V_{GS}$ = 10 V, $I_{D}$ = 20 A, $T_{J}$ = 125 $^{\circ}C$	20 A, T <sub>J</sub> = 125°C					
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = 10 V, $I_{D}$ = 20 A, $T_{J}$ = 175 $^{\circ}C$			0.053			
		$V_{GS}$ = 4.5 V, I <sub>D</sub> = 20 A			0.025			
Forward Transconductanceb	9fs	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$				S		
Dynamic								
Input Capacitance	C <sub>iss</sub>			1800		pF		
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1 MHz		350				
Reverse Transfer Capacitance	C <sub>rss</sub>			100				
Total Gate Charge <sup>c</sup>	Qg			40	60	nC		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, \ V_{GS} = 10 \text{ V}, \ I_D = 40 \text{ A}$		9				
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			10				
Gate Resistance	Rg		1		3.5	Ω		
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			10	20	- ns		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 30 V, R <sub>L</sub> = 0.9 $\Omega$		9	20			
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_{D} \cong$ 20 Å, $V_{GEN}$ = 10 V, $R_{g}$ = 2.5 $\Omega$		28	50			
Fall Time <sup>c</sup>	t <sub>f</sub>			7	15			
Source-Drain Diode Ratings a	nd Characteristic	cs ( $T_{C} = 25^{\circ}C$ )						
Pulsed Current	I <sub>SM</sub>				20	А		
Diode Forward Voltage	V <sub>SD</sub>	$I_{F}$ = 20 A, $V_{GS}$ = 0 V		1.0	1.5	V		
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/µs		48	100	ns		

Notes:

For design aid only; not subject to production testing. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%. Independent of operating temperature. a. b.

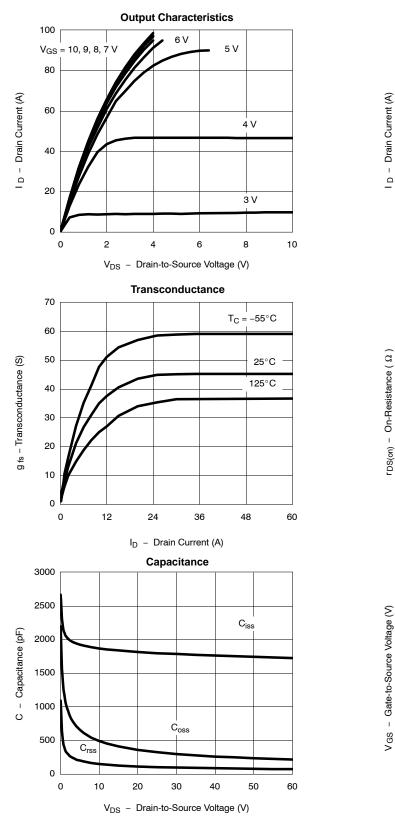
c.

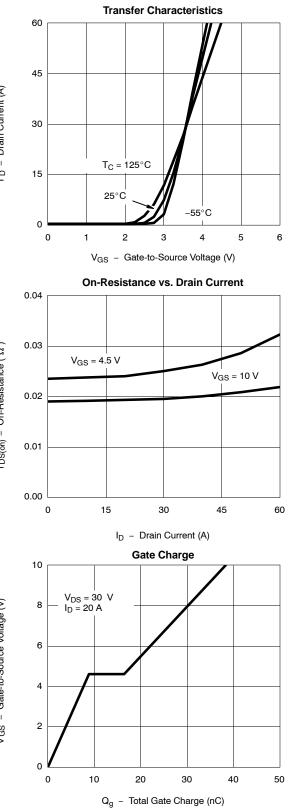
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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#### **TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

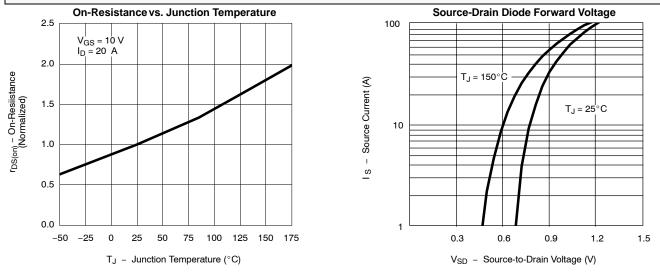




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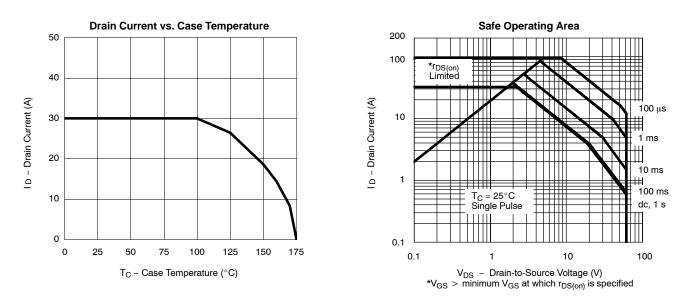
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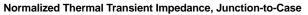


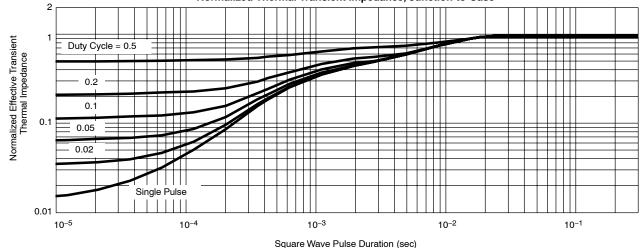


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### THERMAL RATINGS







Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?70264">http://www.vishay.com/ppg?70264</a>.



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